506059701 05/14/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
YUTAKA NAKAMURA	10/30/2018

RECEIVING PARTY DATA

Name:	HUAWEI TECHNOLOGIES CO., LTD.	
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City:	Shenzhen	
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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16756541

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	4747-35700 (85390714US08)	
NAME OF SUBMITTER:	NIDHI BANSAL	
SIGNATURE:	/Nidhi Bansal - Recognition No. L1124/	
DATE SIGNED:	05/14/2020	

Total Attachments: 2

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PATENT 506059701 REEL: 052661 FRAME: 0546

ASSIGNMENT

WHEREAS, I,

Yutaka Nakamura Huawei Administration Building Bantian, Longgang District Shenzhen, 518129, Guangdong P.R.CHINA.

have invented and own a certain invention entitled:

SEALING METHOD

for which invention I have executed an application (provisional or non-provisional) for a U.S. patent, which was filed on 04/16/2020, under U.S. Application No. 16/756,541 and

WHEREAS, HUAWEI TECHNOLOGIES CO.,LTD., Huawei Administration Building Bantian, Longgang District Shenzhen, 518129, Guangdong P.R.CHINA;, hereinafter referred to as Assignee, is desirous of acquiring the entire domestic and foreign right, title, and interest in and under the invention described in the patent application.

Now, THEREFORE, for good and valuable considerations, the receipt and sufficiency of which are hereby acknowledged, I assign and transfer to the Assignee and the Assignee's legal representatives, successors and assigns the full and exclusive rights in and to the invention in the U.S. and every foreign country and the entire right, title, and interest in and to the patent application and other such applications (e.g., provisional applications, non-provisional applications, continuations, continuations-in-part, divisionals, reissues, reexaminations, National phase applications, including petty patent applications, and utility model applications) that may be filed in the United States and every foreign country on the invention, and the patents, extensions, or derivations thereof, both foreign and domestic, that may issue thereon, and I do hereby authorize and request the Commissioner of Patents to issue U.S. patents to the above-mentioned Assignee agreeably with the terms of this assignment document.

I HEREBY AUTHORIZE the Assignee to insert in this assignment document the filing date and application number of the application if the date and number are unavailable at the time this document is executed.

I DO HEREBY COVENANT and agree with the Assignee that I will not execute any writing or do any act whatsoever conflicting with the terms of this assignment document set forth herein, and that I will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to perfect the Assignee's enjoyment of this assignment, and render all necessary assistance in

PATENT REEL: 052661 FRAME: 0547 In re Appln. of Nakamura , Attorney Docket No. 4747-35700

making application for and obtaining original, continuation, continuation-in-part, divisional, reissued, reexamined, and National phase patents of the U.S. or of any and all foreign countries on the invention, and in enforcing any rights or chooses in action accruing as a result of such applications or patents, and by executing statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of all parties hereto.

IN WITNESS WHEREOF, I have hereunder set my hand on the dates shown below.

Date 2018-10-30

Yutaka Nakamura

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